

PUBLICLY AVAILABLE SPECIFICATION



**Electrostatics –
Part 5-6: Protection of electronic devices from electrostatic phenomena –
Process assessment techniques**



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**Electrostatics –
Part 5-6: Protection of electronic devices from electrostatic phenomena –
Process assessment techniques**

INTERNATIONAL
ELECTROTECHNICAL
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CONTENTS

FOREWORD.....	4
1.0 PURPOSE, SCOPE, LIMITATION, and EXPERIENCE LEVEL REQUIRED	9
1.1 Purpose	9
1.2 Scope.....	9
1.3 Limitation	9
1.4 Experience Level Required	9
2.0 Referenced PUBLICATIONS	9
3.0 DEFINITIONS.....	10
4.0 Personnel Safety	10
5.0 Measurement Techniques FOR ESD Risk Assessment	10
6.0 ESD Robustness of ESDS ITEMS used in Processes	12
6.1 ESD Withstand Currents of Single Devices (Components)	13
6.1.1 Human Body Model.....	13
6.1.2 Discharge of Charged Conductors	13
6.1.3 Charged Device Model.....	14
6.2 ESD Withstand Currents of Electronic Assemblies.....	14
6.2.1 Discharge of Charged Personnel	14
6.2.2 Discharge of Charged Conductors.....	14
6.2.3 Discharge of Boards/Systems	15
7.0 Process Assessment Flow	15
7.1 General Considerations.....	15
7.2 Manual Handling Steps	16
7.2.1 Introduction.....	16
7.2.2 Parameter Limits for ESD Process Assessment in Manual Handling Steps.....	16
7.2.3 Detailed ESD Risk Assessment Flow.....	17
7.3 Conductors	18
7.3.1 Introduction.....	18
7.3.2 Parameter Limits for Process Assessment of Conductors.....	19
7.3.3 Detailed ESD Risk Assessment Flow.....	19
7.4 Charged ESDS Items	20
7.4.1 Introduction.....	20
7.4.2 Parameter Limits for Process Assessment of Charged ESDS Items.....	20
7.4.3 Detailed ESD Risk Assessment Flow.....	21
7.5 Risks Due to Process-Required Insulators.....	23
7.5.1 Introduction.....	23
7.5.2 Parameter Limits for Process Assessment of Process-Required Insulators.....	23
7.5.3 Detailed ESD Risk Assessment Flow.....	24
7.6 Process Assessment by ESD Event Detection	25
7.6.1 Introduction.....	25

7.6.2	General Procedure	26
7.6.3	Detailed ESD Risk Assessment Flow.....	26
ANNEX A (INFORMATIVE): Measurement TECHNIQUES And Equipment		28
A.1	General Considerations.....	28
A.2	Measurements of Grounding.....	28
A.3	Measurements of Electrostatic Fields	31
A.4	Measurements of Charges	32
A.5	Measurements of Electrostatic Voltages.....	33
A.6	Measurements of Discharge Events	37
A.7	Measurements of Discharge Currents.....	39
ANNEX B (INFORMATIVE) – PREPARATION: WHAT IS NECESSARY TO PREPARE AN EFFECTIVE PROCESS EVALUATION?		45
B.1	Measurement of Temperature, Humidity, and Basic Electrostatic Conditions	45
B.2	Further Hints for Preparation.....	45
ANNEX C (INFORMATIVE) – Risk Assessment and Mitigation.....		46
ANNEX D (INFORMATIVE) – ExampleS for defining limits in process assessment for Risks Due to Charged Personnel		47
ANNEX E (INFORMATIVE) – Example for CDM risk assessment in a semiconductor manufacturing line.....		49
ANNEX F (INFORMATIVE) – Bibliography		53
ANNEX g (INFORMATIVE) – revision History for ANSI/ESD Sp17.1		54
Table 1 – Overview of Possible Measurement Equipment Used for Different Scenarios to Assess ESD Risk.....		11
Table 2 – Peak Current Ranges of CDM Discharges of Small and Large Verification Modules for Oscilloscopes with a Bandwidth of 1 GHz and 6 GHz According to ANSI/ESDA/JEDEC JS-002.....		44
Table 3 – Recommended Measurement Locations During Process Assessment in Assembly (Pre-Assembly) of Devices.....		49
Table 4 – Recommended Measurement Locations During Process Assessment in Device Testing .		50
Figure 1 – Direct (Best Correlation) and Indirect (Least Correlation) Measurements to Assess an ESD Risk.....		12
Figure 2 – Flow to Assess ESD Risk Induced by Personnel.....		18
Figure 3 – Flow to Assess the ESD Risk Induced by Conductors		20
Figure 4 – Flow to Assess the ESD Risk Induced by Charged ESDS Items		22
Figure 5 – Flow to Assess the ESD Risk Induced by Process-Required Insulators		25
Figure 6 – Flow to Assess the ESD Risk by Detecting the Electromagnetic Radiation Using ESD Event Detectors or Antennas and Oscilloscopes		27
Figure 7 – Examples of Current Probes		40
Figure 8 – Example of a 4-GHz Pellegrini Target		42
Figure 9 – Commercially Available CDM Test Head Used for Discharge Current Measurements.....		43
Figure 10 – Discharge Current Measured in the Field and During Device Qualification [8]		47
Figure 11 – Examples of Measurements During Semiconductor Assembly and Testing		50
Figure 12 – Schematic of Possible CDM-Like Scenarios During Device Testing		52

INTERNATIONAL ELECTROTECHNICAL COMMISSION

ELECTROSTATICS –

Part 5-6: Protection of electronic devices from electrostatic phenomena – Process assessment techniques

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IEC PAS 61340-5-6 has been processed by IEC technical committee 101: Electrostatics.

It is based on ANSI/ESD SP17.1-2020. The structure and editorial rules used in this publication reflect the practice of the organization which submitted it.

The text of this PAS is based on the following document:

This PAS was approved for publication by the P-members of the committee concerned as indicated in the following document

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Following publication of this PAS, the technical committee or subcommittee concerned may transform it into an International Standard.

A list of all parts in the IEC 61340 series, published under the general title *Electrostatics*, can be found on the IEC website.

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***ESD Association Standard Practice for
the Protection of Electrostatic Discharge
Susceptible Items –
Process Assessment Techniques***

Approved November 17, 2020
EOS/ESD Association, Inc.



(This foreword is not part of EOS/ESD Association, Inc. Standard Practice ANSI/ESD SP17.1-2020)

FOREWORD

This standard practice¹ describes a set of methodologies, techniques, and tools that can be used to characterize a process where ESD sensitive (ESDS) items are handled. This document's procedures are meant to be used by those possessing knowledge and experience with electrostatic measurements. This document provides methods to determine the level of ESD risk that remains in the process after ESD protective equipment and materials are implemented.

These test methods' objective is to identify if potentially damaging ESD events are occurring or if significant electrostatic charges are generated on people, equipment, materials, components, or printed circuit board assemblies (PCBA) even though there are static control measures in place.

Sensitivities of items are characterized by industry-standard ESD testing and rated by their withstand voltages. This document is intended to provide methods to determine whether items of a given withstand voltage are at risk in the process.

The wide variety of ESD protective equipment and materials and the environment in which these items are used may require test setups different from those described in this document. Users of this standard practice may need to adapt the test procedure and setups described in Annex A to produce meaningful data for the user's application.

Organizations performing these tests will need to determine if on-going process characterization is necessary, and if so, the time interval between observations. It may also be important to make these observations when new products are introduced or when process changes occur. Examples of process changes may include tools, fixtures, equipment, new items/products, and additional manufacturing steps.

The topics below are not addressed in this document:

- Program Management: see ANSI/ESD S20.20 Protection of Electrical and Electronic Parts, Assemblies and Equipment (Excluding Electrically Initiated Explosive Devices)
- Compliance Verification: see ESD TR53-01 Compliance Verification of ESD Protective Equipment and Materials
- Troubleshooting: ESD TR53-01
- ESD Program Certification: see ANSI/ESD S20.20 Certification Program at www.esda.org

This document was designated ANSI/ESD SP17.1-2020 and approved on November 17, 2020.

¹ **ESD Association Standard Practice:** A procedure for performing one or more operations or functions that may or may not yield a test result. Note, if a test result is obtained it may not be reproducible.

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ESD Association Standard Practice for the Protection of Electrostatic Discharge Susceptible Items – Process Assessment Techniques

1.0 PURPOSE, SCOPE, LIMITATION, AND EXPERIENCE LEVEL REQUIRED

1.1 Purpose

The purpose of this document is to describe a set of methodologies, techniques, and tools that can be used to characterize a process where ESD sensitive (ESDS) items are handled. The process assessment covers risks by charged personnel, ungrounded conductors, charged ESDS items, and ESDS items in an electrostatic field.

1.2 Scope

This document applies to activities that manufacture, process, assemble, install, package, label, service, test, inspect, transport, or otherwise handle electrical or electronic parts, assemblies, and equipment susceptible to damage by electrostatic discharges. This document does not apply to electrically initiated explosive items, flammable liquids, or powders. The document does not address program management, compliance verification, troubleshooting, or program manager/coordinator certification. In this version of the document, risks due to electromagnetic sources that produce AC fields are not considered.

1.3 Limitation

No detailed description of the processes and measurement techniques is given. An example of a simple risk assessment of a discharge from a charged human body is described in Annex D.

Due to the sampling nature in this document's procedures, deficiencies may exist that are not detected at the time the measurements are made. The measurements described are valid only at the time the measurements are made and may or may not change with time.

NOTE: Environmental parameters such as temperature and relative humidity (RH) may significantly impact the measurement results.

1.4 Experience Level Required

The procedures in this document are for use by personnel possessing advanced knowledge and experience with electrostatic measurements. The interpretation of the results from the measurements described in this document requires significant experience and knowledge of the physics of ESD and the process.

2.0 REFERENCED PUBLICATIONS

Unless otherwise specified, the following documents of the latest issue, revision, or amendment form a part of this standard to the extent specified herein:

ESD ADV1.0, ESD Association Glossary of Terms²

ANSI/ESD S20.20, For the Development of an Electrostatic Discharge Control Program for –Protection of Electrical and Electronic Parts, Assemblies and Equipment (Excluding Electrically Initiated Explosive Devices)²

IEC61340-5-1, Electrostatics–Part 5-1: Protection of Electronic Devices from Electrostatic Phenomena – General Requirements³

² EOS/ESD Association, Inc. 7900 Turin Road, Bldg. 3, Rome, NY 13440, Ph: 315-339-6937; www.esda.org

³ IEC – International Electrotechnical Commission, www.iec.ch